

APR 15 2008

04-18-2008

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To the Director of the U.S. Patent and T
Please record the attached original doc

103497565

1. Name of conveying party(ies):
Sung Ho KWAK

Name and address of receiving party(ies):

Name: Dongbu Electronics Co., Ltd.

Additional name(s) of conveying party(ies) attached? ☐ Yes ☒ No

Internal Address:

3. Nature of conveyance:

Street Address: 891-10, Daechi-dong, Gangnam-gu,
Seoul, Korea, 135-280☐ Assignment☐ Merger

City:

☐ Security Agreement☐ Change of Name

State:

Zip Code:

☐ Joint Research
Agreement☐ Government Interest
Assignment

Additional name(s) & Address(es) attached?

☐ Executive Order 9494,
Confirmatory License☒ Other: Correction of
Assignor's Name Recorded at
Reel 018253 Frame 0065☐ Yes☒ No

Execution Date: February 20, 2008

4. Application number(s) or patent number(s): If this document is being filed together with a new application, the execution date of the application:

A. Patent Application Number(s):

11/511,392

B. Patent Number(s):

Additional numbers attached?

☐ Yes☒ No

5. Name and address of party to whom correspondence concerning document should be mailed:

Name: Ernest F. Chapman (202) 408-4000

Internal Address: FINNEGAN, HENDERSON, FARABOW, GARRETT
& DUNNER, L.L.P.

Street Address: 901 New York Avenue, N.W.

City: Washington

State: D.C. Zip: 20001-4413

6. Total number of applications and patents involved:
1

7. Total fee (37 CFR 1.21(h) and 3.41): \$40

☒ Enclosed (please charge deficiency to deposit account)☐ Authorized to be charged to deposit account

8. Deposit Account No.: 06-0916

9. Statement and signature.

To the best of my knowledge and belief, the foregoing information is true and correct and any attached copy is a true copy of the original document.

Signed:

Darrell D. Kinder, Jr.
Reg. No. 57,46004/17/2008 MJAMA1 4/17/08 11511392
01 FC:8021

Date 40.00 0p

Total number of pages including cover sheet, attachments and documents: 6

6/2007

PATENT
REEL: 020829 FRAME: 0809

ASSIGNMENT

WHEREAS I/We, the below named inventor(s), [hereinafter referred to as Assignor(s)], have made an invention entitled:

METHOD FOR MANUFACTURING SEMICONDUCTOR DEVICE USING POLYMER

for which I/WE executed an application for United States Letters Patent concurrently herewith or filed an application for United States Letters Patent on [Date], 20[Year] (Application No. [Text]); and

WHEREAS, **Dongbu Electronics Co., Ltd.**

a corporation of **KOREA**

whose post office address is **891-10, Daechi-dong, Gangnam-gu, Seoul 135-280, Republic of Korea**

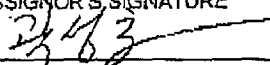
(hereinafter referred to as Assignee), is desirous of securing the entire right, title, and interest in and to this invention, the application for United States Letters Patent on this invention and the Letters Patent to be issued upon this application;

NOW THEREFORE, be it known that, for good and valuable consideration the receipt of which from Assignee is hereby acknowledged, I/WE, as Assignor(s), have sold, assigned, transferred, and set over, and do hereby sell, assign, transfer, and set over unto the Assignee, its lawful successors and assigns, my/our entire right, title, and interest in and to this invention and this application, and all divisions, and continuations thereof, and all Letters Patent of the United States which may be granted thereon, and all reissues thereof; and I/WE hereby authorize and request the Commissioner of Patents and Trademarks of the United States to issue all Letters Patent for this invention to Assignee, its successors and assigns, in accordance with the terms of this Assignment;

AND, I/WE HEREBY further covenant and agree that I/We will, without further consideration, communicate with Assignee, its successors and assigns, any facts known to me/us respecting this invention and testify in any legal proceeding, sign all lawful papers when called upon to do so, execute and deliver all papers that may be necessary or desirable to perfect the title to this invention in said Assignee, its successors and assigns, execute all divisional, continuation, and reissue applications, make all rightful oaths and generally do everything possible to aid Assignee, its successors and assigns, to obtain and enforce proper patent protection for this invention in the United States, it being understood that any expense incident to the execution of such papers shall be borne by the Assignee, its successors and assigns.

AND, I/WE HEREBY authorize and request the attorneys I/we have empowered in the Declaration and Power of Attorney in this application, to insert here in parentheses (Application No.[Text], filed [Date]) the filing date and application number of said application when known.

IN TESTIMONY WHEREOF, I/We have hereunto set our hand(s).

1. FULL NAME OF SOLE OR FIRST ASSIGNOR KWAK, SUNG HO	ASSIGNOR'S SIGNATURE 	DATE February 20, 2008
ADDRESS 103-409, Yeoksam Lucky Apt., Dogok 1-dong, Gangnam-gu, Seoul, Republic of Korea, 135-858		CITIZENSHIP Republic of Korea
2. FULL NAME OF SECOND ASSIGNOR, IF ANY [Text]	ASSIGNOR'S SIGNATURE	DATE
ADDRESS [Text]		CITIZENSHIP [Text]
3. FULL NAME OF THIRD ASSIGNOR, IF ANY [Text]	ASSIGNOR'S SIGNATURE	DATE
ADDRESS [Text]		CITIZENSHIP [Text]

MARCUS KIRK, EXAMINER
ASSIGNMENT SERVICES BRANCH
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